



RoHS Compliant

REV	MODIFICATION	DATE	DRAW
A1	Refer To ECN20110805	2011.08.22	Ivy
A2	Refer To ECN20130202	2013.02.26	Seven
A3	Refer To ECN20141007	2014.10.31	Michelle

Specification

- 1.Current Rating:5A
- 2.Voltage Rating:250V AC/DC
- 3.Contact Resistance:20mΩ Max.
- 4.Insulation Resistance:1000MΩ Min. At DC 500V
- 5.Dielectric Withstanding Voltage:AC1500V/Minute
- 6.Operating Temperature:-25℃~+85℃

Material:

- 1.Housing:Thermoplastic UL94V-2
  - 2.Contact Pin:Copper Alloy SQ. Pin 1.14mm
- Finish:
- 1.Housing:Natural
  - 2.Contact Pin:Bright Tin Plated Over Nickel.

Part No.: AD00100 XX 0 1 5 2

Number of Pin

△3 02~10

Packing

5:Bag

Housing Material

0:NY66 UL94V-2 Nature

Plating

1:Bright Tin Plated Over Nickel



PIN	DIM.A	DIM.B	PIN	DIM.A	DIM.B
02	5.08	10.22	07	30.48	35.62
03	10.16	15.30	08	35.56	40.70
04	15.24	20.38	09	40.64	45.78
05	20.32	25.46	10	45.72	50.86
06	25.40	30.54			



金上達科技股份有限公司

GOLDENSUND TECHNOLOGY CO.,LTD

TOLERANCE UNLESS OTHERWISE SPECIFIED		PROJ.	TITLE: Wire To Board Wafer 5.08mm 180° DIP Single Row		
.x± 0.35	x.*2'	APR. C.F.Liao 20141031	PART NO. AD00100XX0152	DWG NO. AD00100XX0152	
.xx± 0.25	.x.*1'	CHK. Abel 20141031	UNITS: mm	CUSTOMER DRAWING	
.xxx± 0.15	.xx.*0.5'	DRA. Michelle 20141031	SIZE: A4	SCALE 2:1	SHEET 1 / 1
				REV A3	V

